



Build on PMP20531 Rev A PCB

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Orderable:	Designed for: Public Release	Mod. Date: 11/15/2016
TID #: N/A	Project Title: 12V/7.5W Isolated Flyback Converter	
Number: PMP20531	Rev: B	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:	File: PMP20531_RevB_SH1.SchDoc	Size: B
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